

产品介绍/Introduction

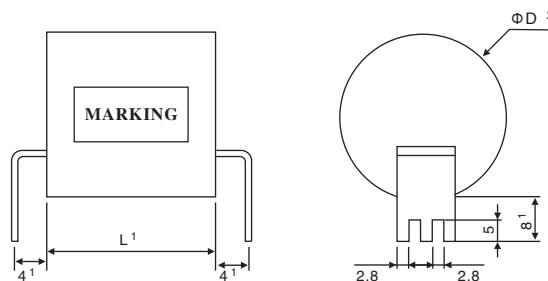
采用耐高温金属化聚丙烯薄膜进行无感式卷绕，特殊喷金工艺，迈拉胶带封装，阻燃环氧树脂灌封，铜螺母引出。具有体积小，杂散电感小，过电流能力强，稳定性好的特点，广泛应用于各类中、高频电子设备的串、并联LC谐振电路。安装简单，方便，搭配灵活。

Non-inductive winding with high temperature resistant metallized polypropylene film, special metal spray, Mylar tape encapsulation, flame retardant epoxy potting, copper nut terminal. With small size, small stray inductance, strong over-current capability, good stability characteristics. Widely used in all kinds of medium and high frequency electronic equipment for LC resonance. Installation is simple, convenient, flexible collocation.

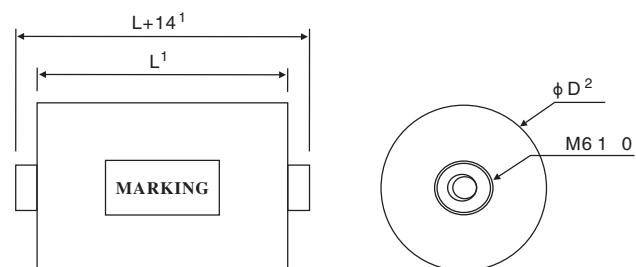
**性能指标/Technical data**

引用标准 Reference	GB/T3984, IEC60110
容量范围 Capacitance	0.022~6.8 μ F
容量偏差 Capacitance Tol.	5% (J), 10%(K)
电压范围 Voltage	400V.AC~4000V.AC
极间耐压 U _{T-T}	2Un/10s
过电压 Over Voltage	1.05Un (12h/day)
可重复峰值电压	1.5Un
过渡状态瞬时电压	3Un
额定有效电流	20~100A
最大允许电流	1.2In ($\leq 60Hz$) 1.15In ($> 60Hz$)
损耗角正切 tg δ	tg δ ≤ 0.0005 (10kHz 20°C)
绝缘电阻 RiX _{Cn}	Cn $\leq 0.33 \mu$ F $\geq 15000M\Omega$ Cn > 0.33 μ F $\geq 10000s$
耐电流冲击能力 dv/dt	> 200V/ μ s
工作温度范围 Operating Temp.	-40°C~85°C/105°C
储存温度范围 Storage Temp.	-40°C~85°C
使用海拔 Max. Altitude	< 2000m
预期寿命 Lifetime Expectancy	30000h (θ h.s=70°C)
封装形式 Encapsulation	迈拉胶带, 白色环氧

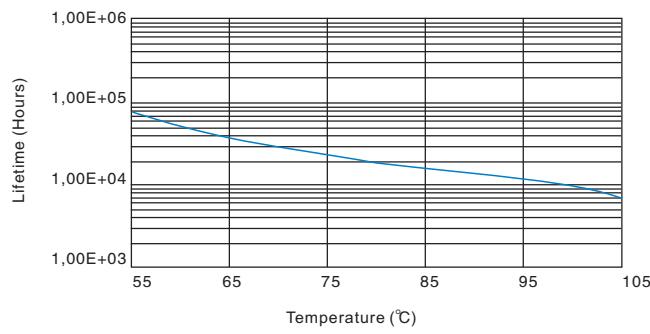
注：海拔使用高度超过2000m，应该考虑海拔对冷却和绝缘的影响。

外型及尺寸/Outline drawing

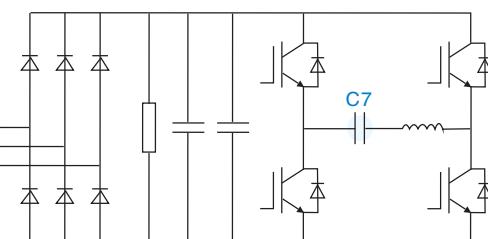
Outline drawing A...



Outline drawing B..

预期使用寿命/Lifetime expectancy for MKPH-R

预期使用寿命/Lifetime Expectancy (hours)

典型线路图/Typical circuit

C7:Resonance Capacitors